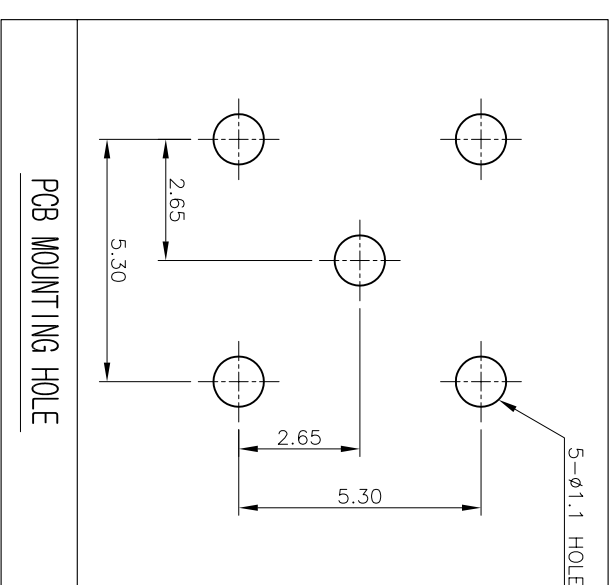
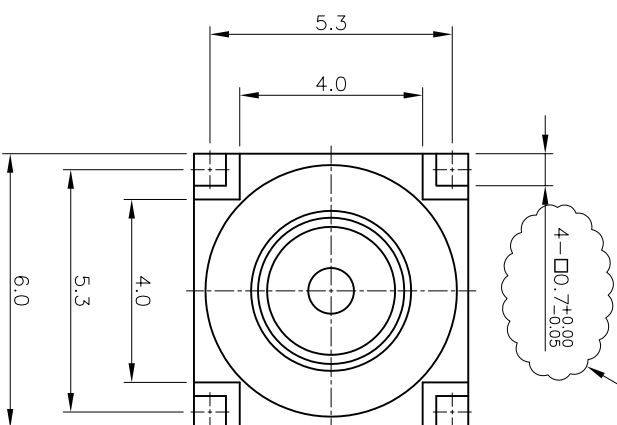
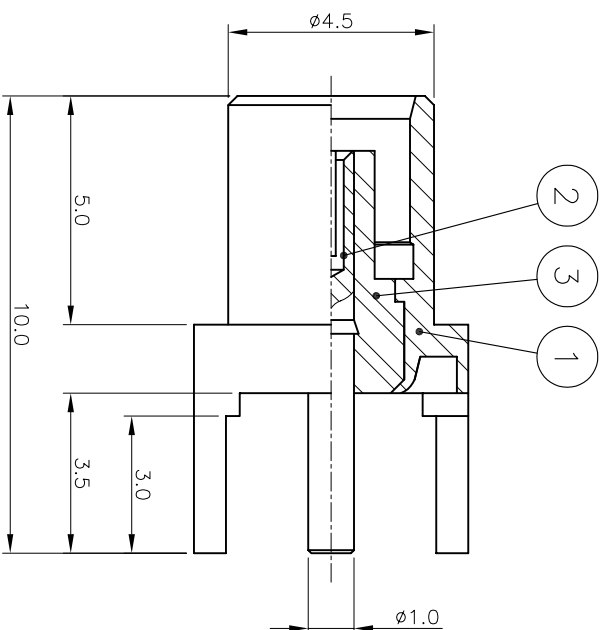


REVISION			DATE
REV	DESCRIPTION		
1	최초 개정	2001. 05. 22.	
A	기타 [설번No.연구200907-0009] 기공 주기 추가	2009. 07. 15.	

△ 라드부 사각 유지 할 것
 ※ 기공 주기 : 1. 사각 원자재 □6 사용
 2. 사각 면취 처리 하지 않음



		3	INSULATOR	1	TEFLON	White	DIN00038-N/1 (H1039)
		2	CONTACT	1	BeCu	Gold Plate	DCT00044-5/1 (E1105)
		1	BODY	1	MBSBD	Gold Plate	DBD00075-5/1 (D1117)
		NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
Decimal ±0.1		DATE		2009. 07. 15.			
TOLERANCE Angle ±1°		APPROVED BY		S.J.YOUN		RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
MATERIAL		CHECKED BY		I.C.KIM		TITLE	
-		DRAWN BY		E.H.KIM		MCX50 PCB JS-4R	
FINISH		SCALE		UNIT		DWG NO.	
-		6/1		mm		A4	
						REVISION	
						A	
						SHEET	
						1 of 1	

TOLERANCE	Decimal
Angle	±0.1
±1°	
MATERIAL	-
FINISH	-

SCALE	UNIT
6/1	mm

A4	REVISION	A	SHEET	1 of 1
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